



## ELC-470-34

Radiation	Type	Electrodes
blue	GaN / sapphire	P + N up

	<p>Description</p> <ul style="list-style-type: none"> <li>- Substrate: Sapphire, epitaxial layer: GaN based material</li> <li>- N bonding pad electrode: Au alloy</li> <li>- P bonding pad electrode: Au alloy</li> </ul> <p>Above drawing is not on real scale</p>
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### Maximum Ratings

$T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test cond.	Symbol	Min	Typ	Max	Unit
Forward current (DC)		$I_F$			20	mA
Peak forward current	$t_p \leq 50 \mu\text{s}$ , $t_p/T = 1/2$	$I_{FM}$			100	mA

### Optical and Electrical Characteristics

$T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test cond.	Symbol	Min	Typ	Max	Unit
Forward voltage	$I_F = 20 \text{ mA}$	$V_F$		3.3	3.5	V
Reverse current	$V_R = 5 \text{ V}$	$I_R$			1	$\mu\text{A}$
Dominant wavelength	$I_F = 20 \text{ mA}$	$\lambda_p$	467	470	473	nm
Full width at half maximum	$I_F = 20 \text{ mA}$	$\Delta\lambda$		30		nm
Luminous intensity	$I_F = 20 \text{ mA}$	$I_v$	260	280	300	mcd

### Packing

Chips on adhesive film with wire-bond side top

